583631-1 ✓ ACTIVE

AMP-LEAF | CGS HS

TE Internal #: 583631-1

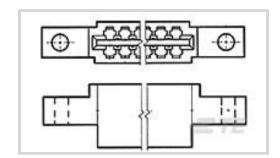
Card Edge Connector Housings, Board-to-Board, 30 Position, .156 in [3.96 mm] Centerline, 30 Dual Positions, Printed Circuit Board,

Power, CGS HS

View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > Card Edge Connector Housings



Connector System: Board-to-Board

Number of Positions: 30

Centerline (Pitch): 3.96 mm [.156 in]
Row-to-Row Spacing: 3.96 mm [.156 in]

Number of Dual Positions: 30

Features

Product Type Features

Board-to-Board
No
Printed Circuit Board
30
30
5 A
Board Mount
3.96 mm[.156 in]
3.96 mm[.156 in]
-55 – 105 °C[-67 – 221 °F]

Operation/Application



Circuit Application	Power	
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Product Compliance

For compliance documentation, visit the product page on TE.com>

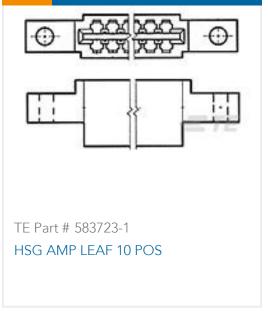
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2019 (197) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | CGS HS





Automotive Housings(2)



Card Edge Connector Housings(2)



Chassis Mount Resistors(535)



FFC Connectors(1)



High Speed Backplane Connectors(11)



Plug & Socket Lighting Connector Accessories(1)



RJ45 Connectors(1)



Wire-to-Board Connector Assemblies & Housings(2)

Documents

Product Drawings

HSG AMP LEAF 30 POS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_583631-1_AB.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_583631-1_AB.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_583631-1_AB.3d_stp.zip

English

Customer View Model

ENG_CVM_583631-1_S.3d_igs.zip

English

Customer View Model

ENG_CVM_583631-1_S.3d_stp.zip

English

Customer View Model

ENG_CVM_583631-1_S.2d_dxf.zip

English

3D PDF



3D

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Product Specifications

Product Specification

English

Connector, AMP-LEAF, .000030 Gold Plated Contacts, DPH Housing

English

Product Specification

English

Connector, AMP-LEAF, Phenolic or Thermoplastic Housing

English

Product Specification

English

Connector, AMP-LEAF, Tin Plated Contact

English

Agency Approvals

Agency Approval Document

English